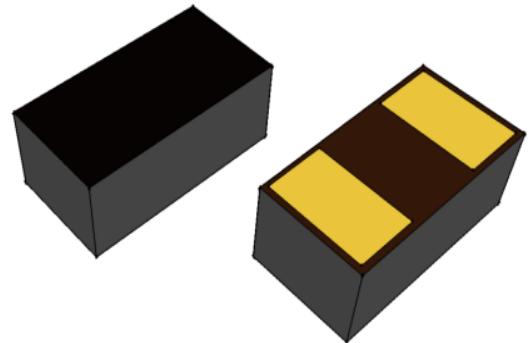




Features

- The best ESD protection for high speed, low voltage applications
- RoHS compliant and halogen free
- Ultra low capacitance, 0.05 pF (typ.)
- Low leakage current (<100nA)
- Fast response time (<1ns)
- Bi-directional, single line protection
- Surface mount



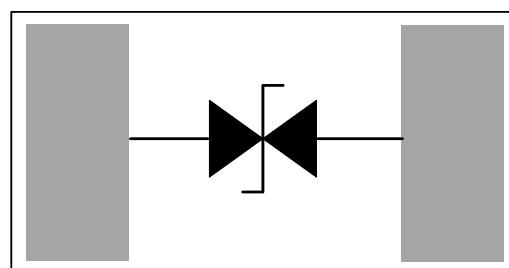
Applications

- High Definition Multi-Media Interface(HDMI)
- Gigabit Ethernet
- Antennas
- High Speed Ethernet
- USB 2.0 and USB 3.0
- Lightning and Thunder Bolt Interface

Mechanical Data

- Surface mount
- RoHS Compliant
- Halogen Free

Schematic & PIN Configuration





Absolute Maximum Rating

Rating	Symbol	Conditions	Value	Units
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}		25 15	kV
Lead Soldering Temperature	T _L		260(10seconds)	°C
Operating Temperature	T _O		-55 to + 125	°C
Storage Temperature	T _{stg}		-55 to + 125	°C

Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Continuous Operating Voltage	V _{DC}				5	V
Trigger Voltage	V _T	IEC61000-4-2 8KV contact discharge		300		V
Leakage Current	I _L	V _{DC} =5V,T=25°C		10	100	nA
Clamping Voltage	V _C	IEC61000-4-2 8KV contact discharge		35		V
Capacitance	C _P	Measured at 10MHz		0.05		pF
ESD Pulse Withstand	Pulses	IEC61000-4-2 8KV contact discharge	1000			



ESD Clamping Test

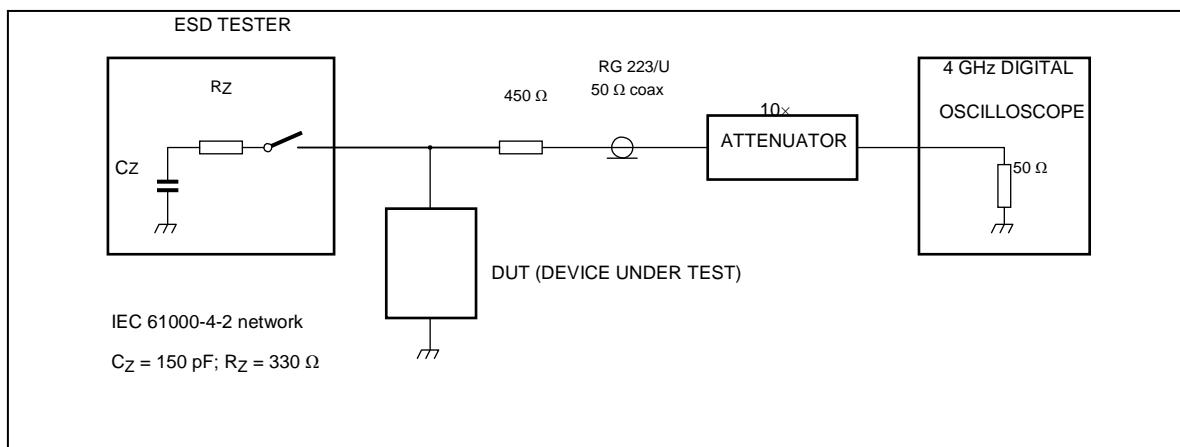


Fig.1 ESD Clamping Test Waveform

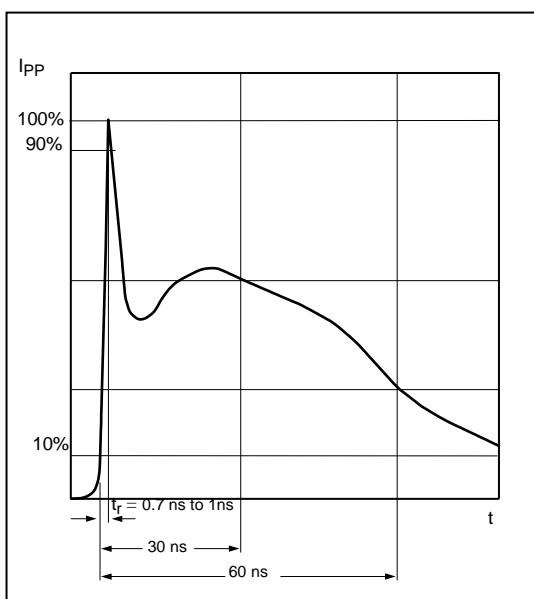


Fig.2 ESD Waveform after Clamping

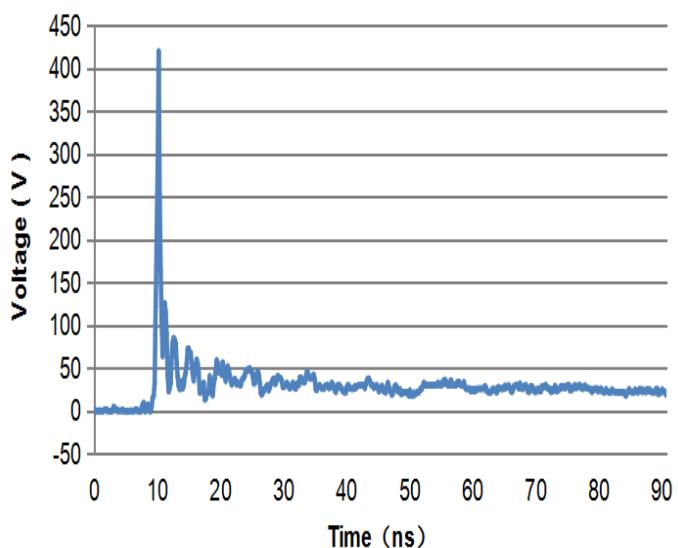
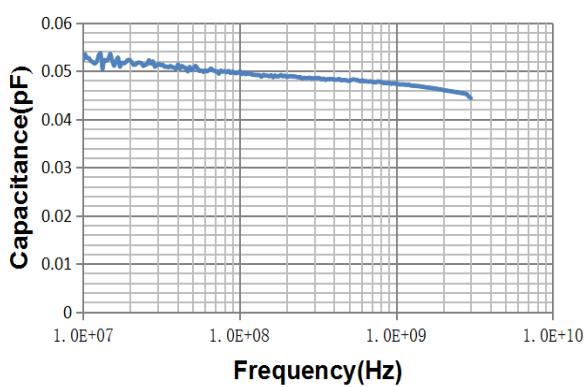
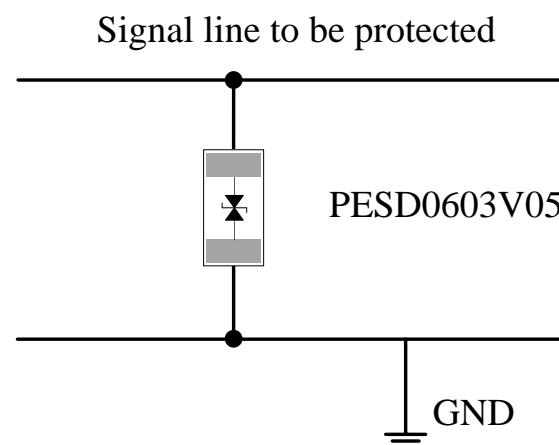


Fig.3 Capacitance VS Frequency

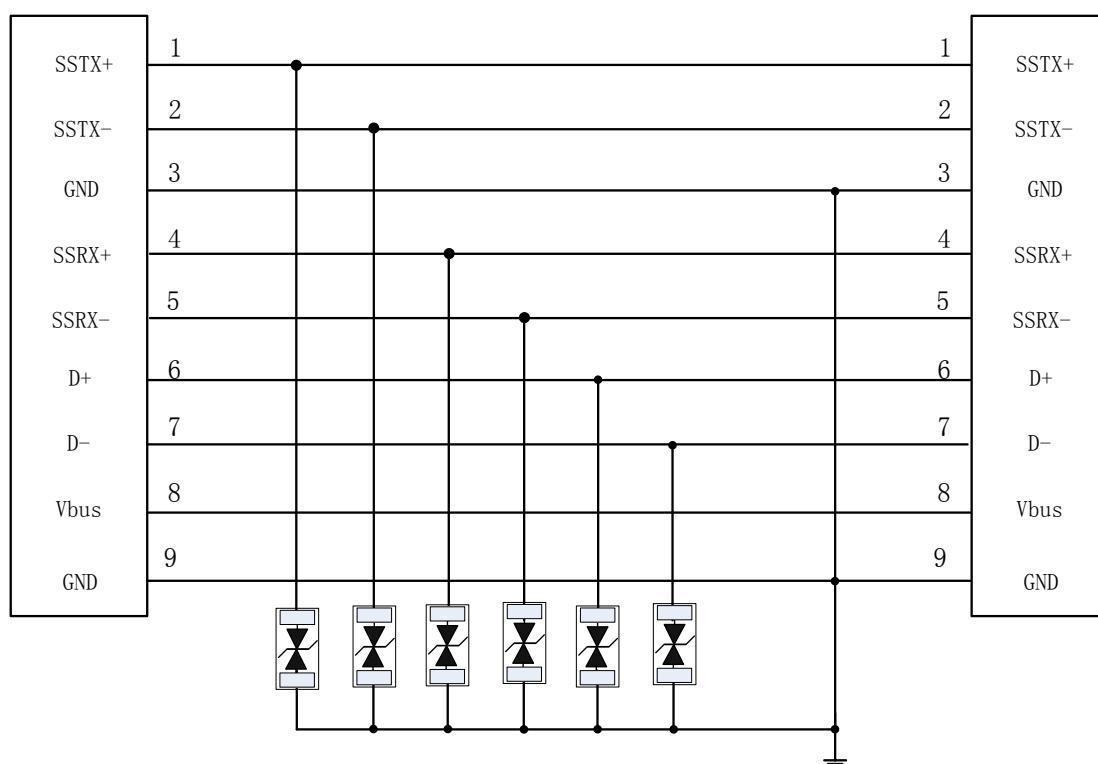




Application Information



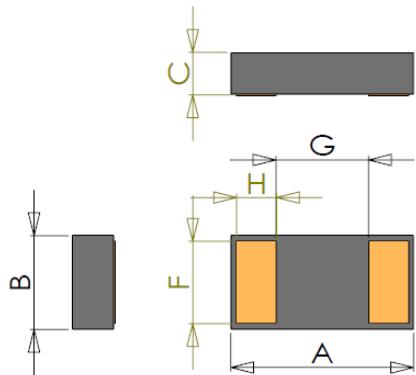
PESD0603V05 in Signal line protected



PESD0603V05 in USB3.0 application



Outline Drawing



Symbol	Dimension			Unit
	Min	Typ	Max	
A	1.50	1.60	1.70	mm
B	0.70	0.80	0.90	
C	0.32	0.36	0.4	
H	0.345	0.365	0.385	
F	0.715	0.735	0.755	
G	0.78	0.80	0.82	